BOARD TITLE: DRIVERS\_LVDS

**AUTHOR: CCB** 

**CODE NUMBER:** 

REVISION: 1\_02

**LAYER STACKUP:** 

TOP / BOTTOM: GND PLANE + SIGNALS

## **GENERAL NOTES:**

# 1. LAMINATE SPECIFICATIONS:

- TOTAL THICKNESS: 1.6 mm +/- 0.2 mm

- LAYER NUMBERS: 2

- Cu THICKNESS (FINISHED): 1 oz / 1 oz

- RAW MATERIAL: FR-4

- TG MIN.: 150 °C

- TD MIN.: 310 °C

## 2. HOLE CHARACTERISTICS:

- PLATED HOLE TOLERANCE: +/- 0.1 mm

- NON PLATED HOLE TOLERANCE: +/- 0.1 mm

- DISPLACEMENT: 0.1 mm MAX.

- Cu THICKNESS ON HOLE: 20 um + SnPb MIN.

## 3. FINISHING:

- HOT AIR SOLDER LEVELING (HASL) - SnPb

# 4. SILKSCREEN MASK:

**REVISIONS DESCRIPTION:** 

1\_00 - Initial revision - jul-22-2016

- WHITE (THERMAL CURE EPOXY)

## 5. SOLDER MASK:

- BOTH SIDES
- GREEN EPOXY THERMAL CURE OR PHOTO IMAGEABLE
- IONIC CONTAMINATION AFTER SOLDERING: 14 ug NaCl / in2 MAX.

1 01 - R1 pull down + R4 pull up + SpW groups silks + test points - nov/2016

1 02 - Tx/Rx connectors changed to Axonn cable model - dez/2016

- COVER VIAS WITH SOLDER MASK ON BOTH SIDES
EXCEPT ON CN21 BORDERS, AS INDICATED IN GERBER

## **6. SPECIFIED STANDARDS:**

- IPC-6011 CLASS 2 / IPC-6012 CLASS 2 / IPC-A-600 CLASS 2

## 7. ADDITIONAL NOTES:

- DIMENSIONAL TOLERANCE: +/- 0.2 mm
- ELECTRICAL TESTS ARE MANDATORY
- GERBER MODIFICATIONS ARE ONLY ALLOWED WITH EXPLICIT AUTHOR / RESPONSIBLE AUTHORIZATION



